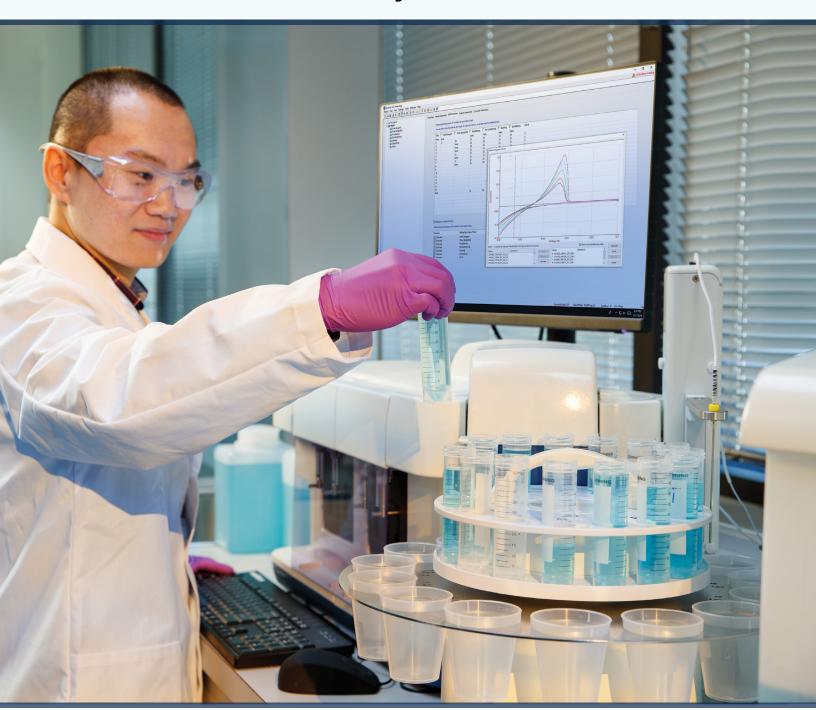
QUALILAB ELITE®

Benchtop Plating Bath Analyzers for Reliable and Fast Analyses





QUALILAB ELITE Benchtop Plating Bath Analyzer

Introducing the all-new QualiLab Elite®
Benchtop Plating Bath Analyzer from ECI
Technology, the company that pioneered
Cyclic Voltammetric Stripping (CVS) analyzers
and has fine-tuned analyzer systems for over
30 years.

This leading analyzer combines CVS and potentiometric titration techniques in a single lab instrument. The analyzer delivers the analytical performance you need to control today's rapidly evolving technologies for printed circuit boards (PCB) and other advanced metal deposition applications. The system, with its combined application-specific analytical methods, provides accurate analysis to establish and maintain correct component concentrations in the processing solutions.

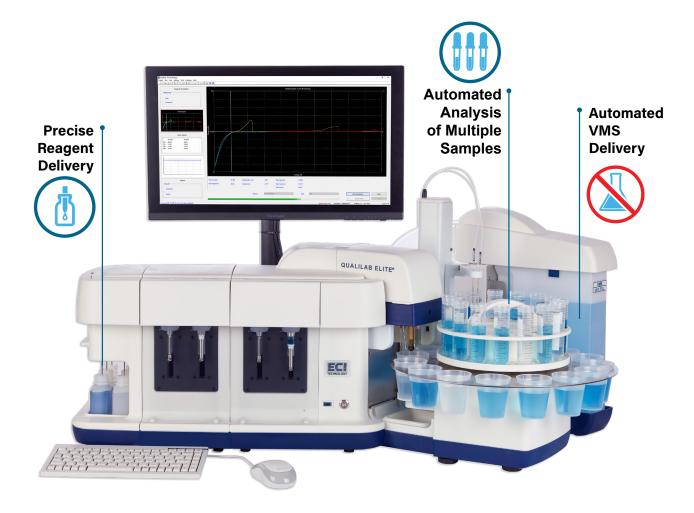
As feature sizes and process windows continue to shrink, the QualiLab Elite analyzer's precise measurement capabilities are essential to providing better controls and efficiency to maximizing the yield, reliability, and profitability of your manufacturing process.

Optimized, Accurate, and Fast Selectivity

The QualiLab Elite analyzer offers precise analyses in an ergonomic design and supports multi-language operations. The modular configurations range from a compact, streamlined single-sample manual analyzer to a fully automated closed-cell system that can measure up to 42 samples without the intervention of operators. All models are streamlined with a minimum of external components. All analyzer models enable high-precision and highly selective analyses and are integrated with user-friendly software, sophisticated data handling, and reporting.

Largest Library of Analytical Recipes for Metal Deposition

Through decades of experience, ECI Technology's scientists developed the industry's largest number of chemistry-specific recipes, ChemPacks®. Combined with the QualiLab Elite analyzer, these proprietary certified analytical recipes enable continued metrology support when implementing new and existing plating chemistries to ensure your plating process requirements of today and into the future.



Applications

- Electroless Deposition buffering agents, complexing agents, reducing agents, and background ions in Cu, Co, Pd, and Ni
- Electroplating organic additives and inorganic bath constituents for Ni, Cu, Sn, SnPb, SnAg, Co, Pd, Zn, and Pd

Analytical Techniques

- Electrochemical analysis MLAT, DT, RC, QC, LAT, RDT, SBP, and DPA
 - Electrode potential
 - CVS, CPVS
 - MPVS, Chronoamperometry, and Chronopotentiometry (optional)
- Potentiometric Titration (optional) direct and back titration

Features

- Easy-to-use software includes the following:
 - "Get Me Expert" feature provides easily accessible remote and factory-supported troubleshooting
 - Flexibility in programming methods and automation
 - Embedded user help
 - Analysis of all additive components on the same turntable
 - Communications: TCP/IP Networking and LIMS
 - Sophisticated reporting and data handling, such as statistics, history management and trend analysis
- Multi-language operation

Advantages

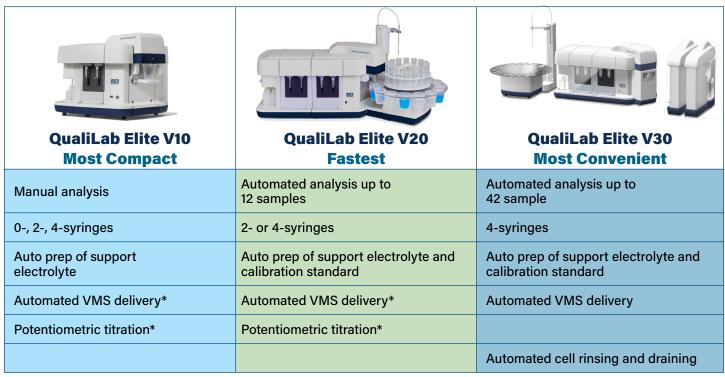
CVS Analysis

- Largest application library
- Temperature controlled CVS analysis cell
- Excellent selectivity
- User-independent accuracy especially for MLAT analytical techniques
- Low-maintenance reference electrode
- Built-in galvanostat for advanced electrochemistry

Automation Options

- Automated preparation of support electrolyte and calibration standards
- Waste removal
- DI Water spray cleaning
- Virgin Makeup Solution (VMS) delivery

Configuration Options



QUALILAB ELITE Benchtop Plating Bath Analyzer



Combines analytical techniques in a single benchtop lab instrument:

- CVS analysis
- Potentiometric titration

Electroplating processes play a critical role in the manufacturing of electronic devices. These processes rely on the use of organic additives – suppressors, accelerators and levelers, and inorganic components – that selectively control deposition, allowing the process to be tuned to a desired deposition profile. Plating bath analysis is required to precisely maintain the balance of multiple components to ensure void-free, bottom-up filling of small, high-aspect-ratio features and other functional properties. The QualiLab Elite system, with its combined application-specific analytical methods, provides accurate analysis for easy replenishment and improved yield from your plating solutions.

Request a demonstration today.

Backed by ECI Technology's Global Support

Contact us for more details. Call or visit us online:

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We Keep Your Chemistry Right[™]

